

N-Channel 40-V (D-S) MOSFET



RoHS
COMPLIANT

| PRODUCT SUMMARY | | | |
|---------------------|---------------------------------|------------------------------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (mΩ)(Typ.) | I _D (A) ^{a, e} | Q _g (Typ.) |
| 40 | 7.3 at V _{GS} = 10 V | 65 | 29 nC |
| | 10.8 at V _{GS} = 4.5 V | 55 | |

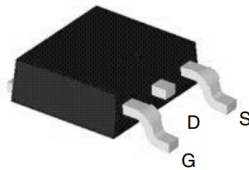
FEATURES

- DT-Trench Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2011/65/EU

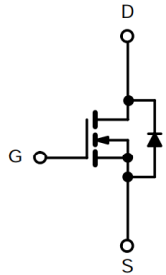
APPLICATIONS

- OR-ing
- Server
- DC/DC

TO-252 Pin Configuration



Top View



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted) | | | | |
|---|-----------------------------------|------------------------|----------------------|-----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 40 | V | |
| Gate-Source Voltage | V _{GS} | ± 20 | | |
| Continuous Drain Current (T _J = 175 °C) | I _D | T _C = 25 °C | 65 ^{a, e} | |
| | | T _C = 70 °C | 50 ^e | |
| | | T _A = 25 °C | 20.8 ^{b, c} | |
| | | T _A = 70 °C | 19 ^{b, c} | |
| Pulsed Drain Current | I _{DM} | 195 | A | |
| Avalanche Current Pulse | L = 0.1 mH | I _{AS} | | 60 |
| Single Pulse Avalanche Energy | | E _{AS} | | 142 |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | 65 ^{a, e} | |
| | | T _A = 25 °C | 2.3 ^{b, c} | |
| Maximum Power Dissipation | P _D | T _C = 25 °C | 80 ^a | |
| | | T _C = 70 °C | 51 | |
| | | T _A = 25 °C | 3.05 ^{b, c} | |
| | | T _A = 70 °C | 1.95 ^{b, c} | |
| Operating Junction and Storage Temperature Range | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|---|--------------|-------------------|------|------|------|
| Parameter | Symbol | Typ. | Max. | Unit | |
| Maximum Junction-to-Ambient ^{b, d} | t ≤ 10 sec | R _{thJA} | 32 | 40 | °C/W |
| Maximum Junction-to-Case | Steady State | R _{thJC} | 0.5 | 0.6 | |

Notes:

- Based on T_C = 25 °C.
- Surface mounted on 1" x 1" FR4 board.
- t = 10 sec.
- Maximum under steady state conditions is 90 °C/W.
- Calculated based on maximum junction temperature.

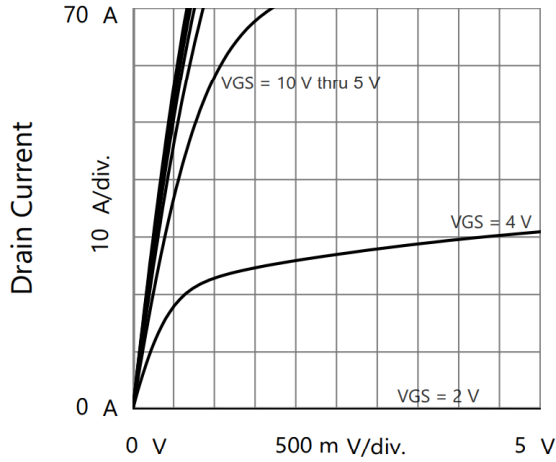
| SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted) | | | | | | | |
|--|-------------------------|--|------|-------|-----------|----------------------|----|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$ | 40 | | | V | |
| V_{DS} Temperature Coefficient | $\Delta V_{DS}/T_J$ | $I_D = 250\text{ }\mu\text{A}$ | | 35 | | mV/ $^\circ\text{C}$ | |
| $V_{GS(th)}$ Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | | | - 7.5 | | | |
| Gate-Source Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$ | 1.0 | | 3.0 | V | |
| Gate-Source Leakage | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 40\text{ V}, V_{GS} = 0\text{ V}$ | | | 1 | μA | |
| | | $V_{DS} = 32\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$ | | | 10 | | |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} \geq 5\text{ V}, V_{GS} = 10\text{ V}$ | 65 | | | A | |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | $V_{GS} = 10\text{ V}, I_D = 30\text{ A}$ | | 7.3 | 8.5 | m Ω | |
| | | $V_{GS} = 4.5\text{ V}, I_D = 20\text{ A}$ | | 10.8 | 12 | | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 5\text{ V}, I_D = 30\text{ A}$ | | 50 | | S | |
| Dynamic^b | | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 20\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | | 1790 | | pF | |
| Output Capacitance | C_{oss} | | | 134 | | | |
| Reverse Transfer Capacitance | C_{rss} | | | 112 | | | |
| Total Gate Charge | Q_g | $V_{DS} = 20\text{ V}, V_{GS} = 10\text{ V}, I_D = 30\text{ A}$ | | 29 | | nC | |
| Gate-Source Charge | Q_{gs} | | | 3 | | | |
| Gate-Drain Charge | Q_{gd} | | | 11.5 | | | |
| Gate Resistance | R_g | $f = 1\text{ MHz}$ | | 2.8 | | Ω | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 20\text{ V}, R_L = 0.625\text{ }\Omega$ $I_D \cong 30\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\text{ }\Omega$ | | 18 | | ns | |
| Rise Time | t_r | | | 11 | | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 70 | | | |
| Fall Time | t_f | | | 10 | | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 20\text{ V}, R_L = 0.67\text{ }\Omega$ $I_D \cong 20\text{ A}, V_{GEN} = 4.5\text{ V}, R_g = 1\text{ }\Omega$ | | 55 | | | |
| Rise Time | t_r | | | 180 | | | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 55 | | | |
| Fall Time | t_f | | | 12 | | | |
| Drain-Source Body Diode Characteristics | | | | | | | |
| Continuous Source-Drain Diode Current | I_S | $T_C = 25\text{ }^\circ\text{C}$ | | | 65 | A | |
| Pulse Diode Forward Current ^a | I_{SM} | | | | 195 | | |
| Body Diode Voltage | V_{SD} | $I_S = 30\text{ A}$ | | 0.8 | 1.2 | V | |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 30\text{ A}, di/dt = 100\text{ A}/\mu\text{s}, T_J = 25\text{ }^\circ\text{C}$ | | 40 | | ns | |
| Body Diode Reverse Recovery Charge | Q_{rr} | | | | 66 | | nC |
| Reverse Recovery Fall Time | t_a | | | | 20 | | ns |
| Reverse Recovery Rise Time | t_b | | | | 19 | | |

Notes:

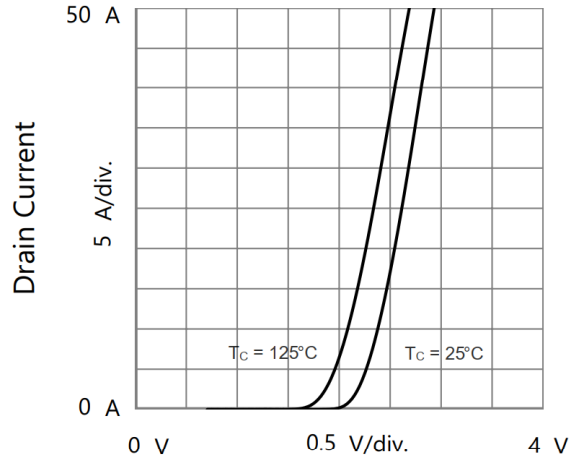
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

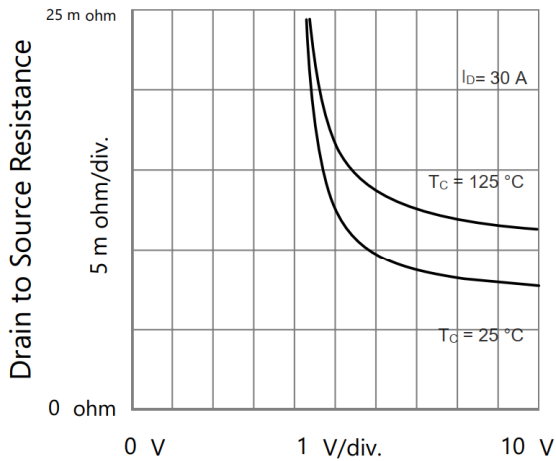
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



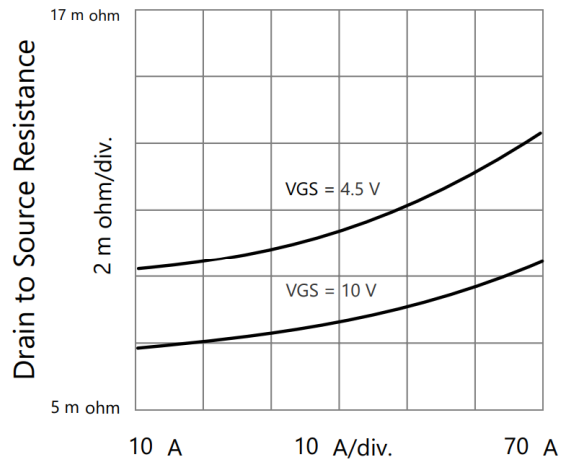
Drain to Source Voltage
Output Characteristics



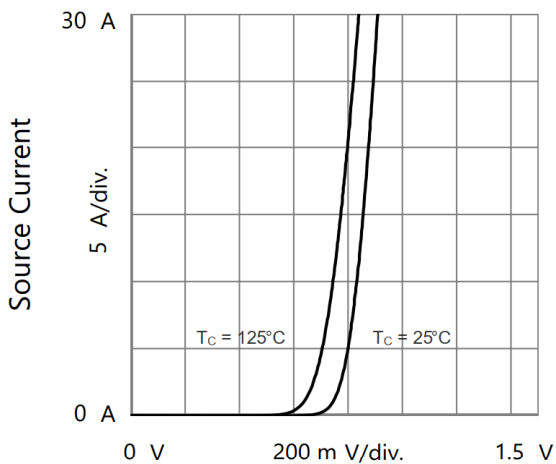
Gate to Source Voltage
Transfer Characteristics



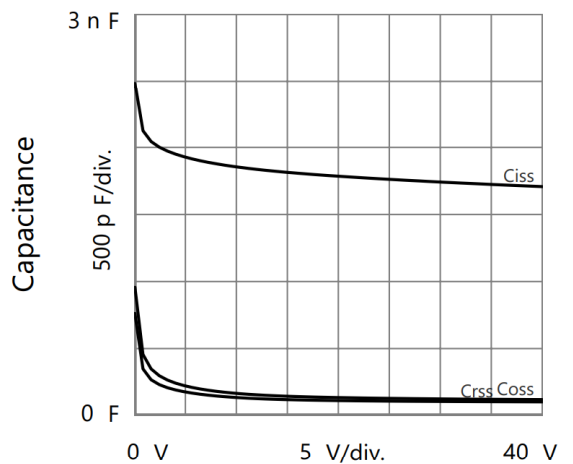
Gate to Source Voltage
Drain to Source Resistance vs. Gate to Source Voltage



Drain Current
Drain to Source Resistance vs. Drain Current

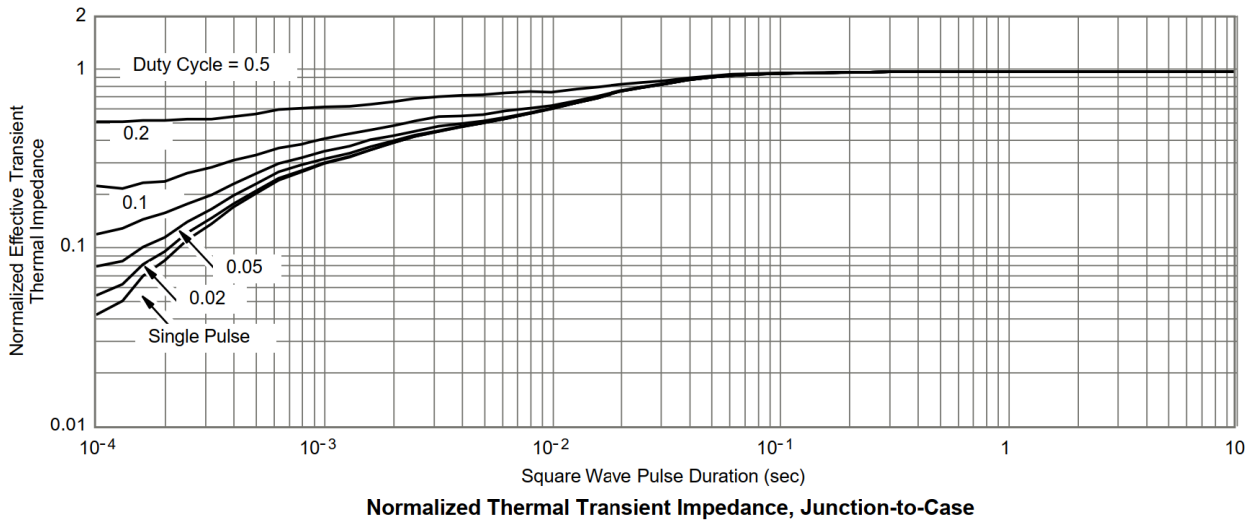
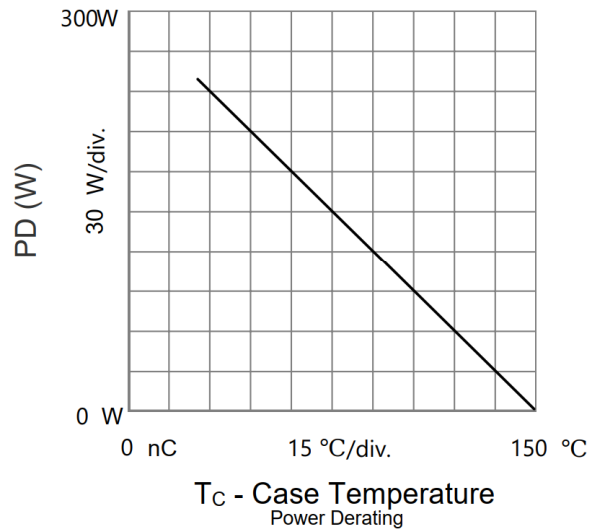
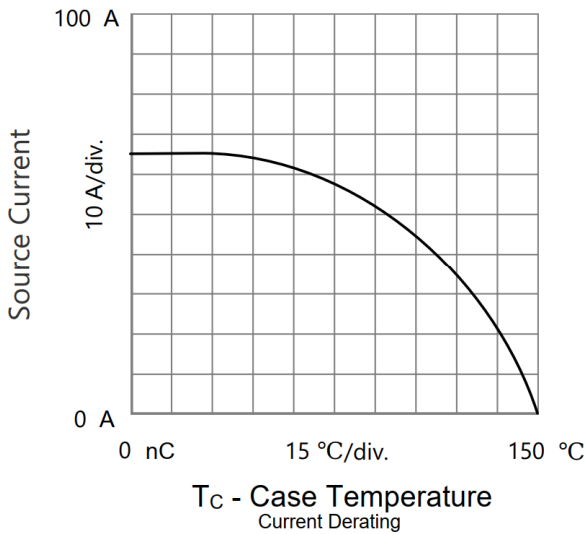
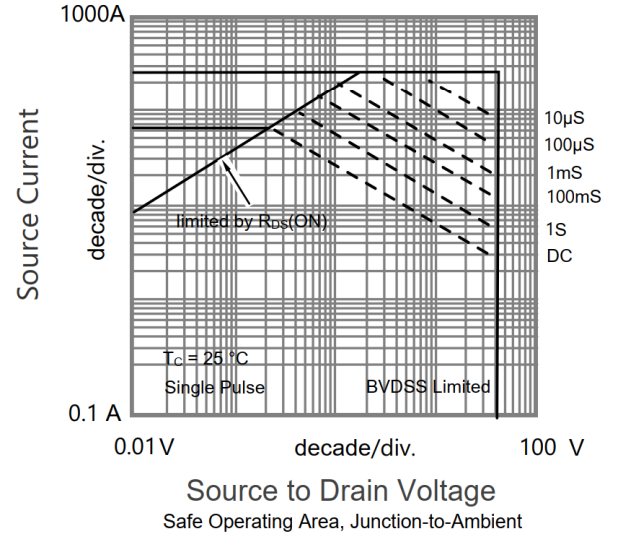
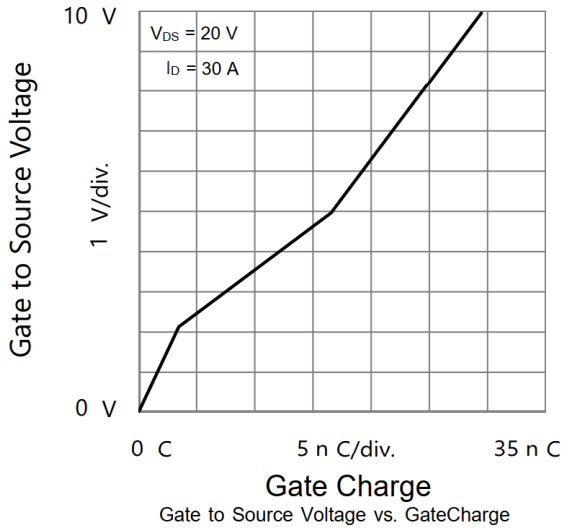


Source to Drain Voltage
Body Diode Forward Characteristics

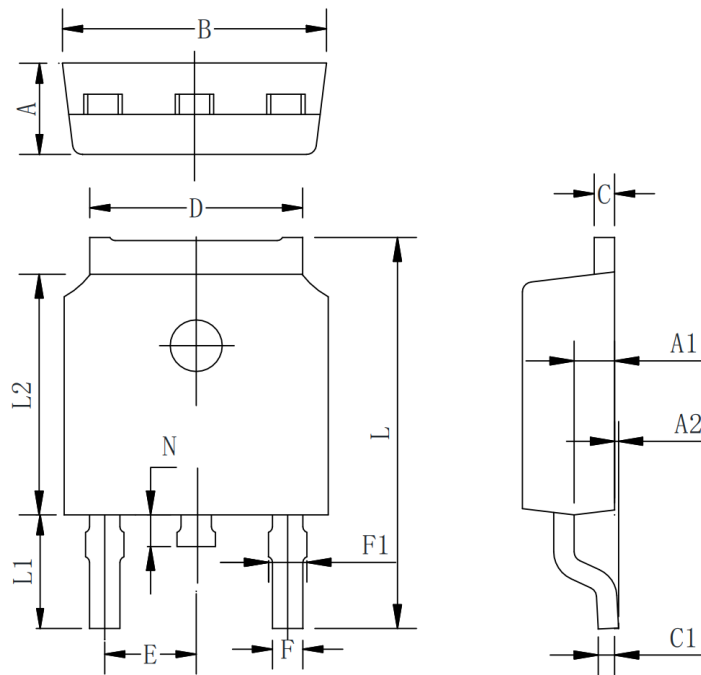


Drain to Source Voltage
Capacitances

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TO-252-2L PACKAGE OUTLINE



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

| Symbol | Min | Typ | Max |
|--------|-----------|------|-------|
| A | 2.10 | 2.30 | 2.50 |
| A1 | 0.88 | 1.01 | 1.16 |
| A2 | 0.00 | 0.15 | 0.28 |
| B | 6.40 | 6.60 | 6.80 |
| C | 0.42 | 0.50 | 0.63 |
| C1 | 0.42 | 0.50 | 0.63 |
| D | 5.08 | 5.32 | 5.65 |
| E | 2.286 TYP | | |
| F | 0.63 | 0.76 | 0.89 |
| F1 | 0.64 | 0.86 | 1.08 |
| L | 9.30 | 9.90 | 10.80 |
| L1 | 2.4 | 2.8 | 3.6 |
| L2 | 5.90 | 6.10 | 6.55 |
| N | 0.57 | 0.80 | 1.05 |

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